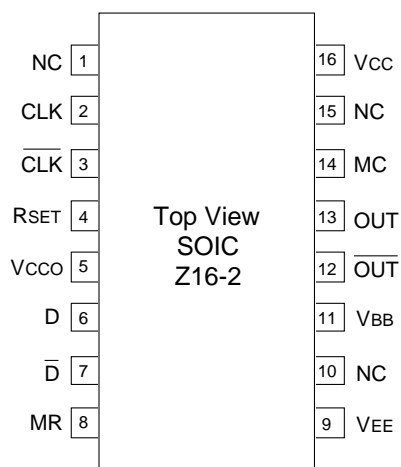


## FEATURES

- Up to 1.25Gb/s operation
- 75mA peak drive current
- Separate modulation control
- Separate master reset for laser safety
- Differential inputs for data and clock
- 75K $\Omega$  input pulldown resistor
- Single power supply
- Available in 16-pin SOIC package

## PIN CONFIGURATION



## DESCRIPTION

The SY100EL1001 is a high speed current source for driving a semiconductor laser diode in optical transmission applications. The output current modulation is DC – voltage controlled. The integrated circuit contains the following functional blocks:

- Input Line Receiver
- D Flip-Flop
- Bias Control Circuitry
- Output Current Switch

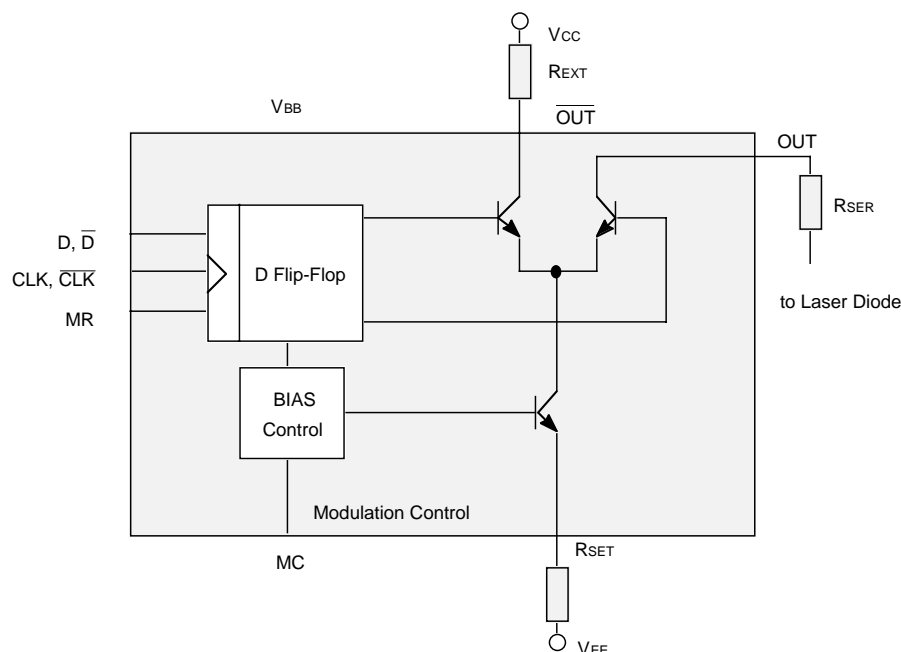
A logic HIGH level at the data input results in the modulation current flowing through the OUT pin on the next rising edge of the clock. A logic HIGH level at the master reset input will disable the modulation current.

The device incorporates complementary open collector outputs with a capability of driving peak current of 75 mA.

The laser driver current is adjustable by selection of RSET. The resistor REXT must be placed between /OUT and VCC to dissipate the worst case power. RSER is recommended to fix laser diode matching issues.

The SY100EL1001 utilizes the high performance bipolar ASSET™ technology.

## BLOCK DIAGRAM



**PIN NAMES**

Pin	Function
$V_{CC}, V_{CCO}$	Most positive power supply pins separation helps to isolate sensitive circuitry from noise generating function. +5V for PECL operation or ground for ECL operation.
$V_{EE}$	Most negative power supply input. Ground for PECL operation or -5V for ECL operation.
$V_{BB}$	This pin provides a reference voltage for use in single ended applications or when the input signal is AC coupled into the device.
D,/D	These differential ECL/PECL 100K compatible inputs receive NRZ data.
CLK, /CLK	These differential clock inputs
MR	This ECL/PECL 100K compatible input resets the Laser Driver Logic - modulation current transitions to zero when asserted high.
OUT, /OUT	Open collector outputs from the modulation buffer drive these differential current outputs.
MC	An external voltage sets the main value of modulation current $I_O$ .
$R_{SET}$	An external resistor sets the source current for modulation $I_{mod}$ .
NC	These pins are not connected.

**TRUTH TABLE<sup>(1)</sup>**

D	/D	CLK	/CLK	MR	OUT	/OUT
L	H	Z	ZZ	L	H	L
H	L	Z	ZZ	L	L	H
X	X	X	X	H	H	L

**NOTE:**

1. L = LOW, H = HIGH, Z = LOW-to-HIGH transition, ZZ = HIGH-to-LOW transition, X = don't care.

**ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>**

Symbol	Rating	Value	Unit
$V_{CC}$	Power Supply Voltage ( $V_{CC} = 0V$ )	0 to -7.0	V
$V_{IN}$	Input Voltage ( $V_{CC} = 0V$ )	0 to -6.0	V
$I_{OUT}$	Output Current	75	mA
$T_A$	Operating Temperature Range	-40 to +85	°C
$P_D$	Power Dissipation	500	mW

**NOTE:**

1. Permanent device damage may occur if ABSOLUTE MAXIMUM RATINGS are exceeded. This is a stress rating only and functional operation is not implied at conditions other than those detailed in the operational sections of this data sheet. Exposure to ABSOLUTE MAXIMUM RATING conditions for extended periods may affect device reliability.

**OPERATIONING CONDITIONS<sup>(1)</sup>**

Symbol	Rating	Value	Unit
$V_{EE}$	Power Supply Voltage	-4.75 to -5.25	V
$R_{SET}$	Resistor to Adjust Current	10 to 100	$\Omega$
$R_{EXT}$	Resistor to Dissipate Power	10 to 50	$\Omega$
$R_{SER}$	Laser Diode Serial Resistor	0 to 50	$\Omega$

**NOTE:**

1. The voltage drop across  $R_{EXT}$  and  $R_{SER}$  should not be greater than 2V.

**DC ELECTRICAL CHARACTERISTICS<sup>(1)</sup>**
 $V_{CC} = V_{CCO} = 0V$ ;  $V_{EE} = -5.0V \pm 5\%$ 

Symbol	Parameter	$T_A = -40^\circ C$			$T_A = 0^\circ C$			$T_A = +25^\circ C$			$T_A = +85^\circ C$			Unit
		Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.	
$V_{IH}$	Input HIGH Voltage (D, CLK, MR)	-1165	—	-880	-1165	—	-880	-1165	—	-880	-1165	—	-880	mV
$V_{IL}$	Input LOW Voltage (D, CLK, MR)	-1810	—	-1475	-1810	—	-1475	-1810	—	-1475	-1810	—	-1475	mV
$V_{I\text{mod}}$	Input Voltage (Modulation Control)	$V_{EE}$	—	$V_{CC}$	$V_{EE}$	—	$V_{CC}$	$V_{EE}$	—	$V_{CC}$	$V_{EE}$	—	$V_{CC}$	V
$V_{BB}$	Output Reference Voltage	-1380	—	-1260	-1380	—	-1260	-1380	—	-1260	-1380	—	-1260	mV
$I_{IH}$	Input HIGH Current (D, CLK, MR)	—	—	150	—	—	150	—	—	150	—	—	150	$\mu A$
$I_{I\text{mod}}$	Input Current (Modulation Control)	—	—	150	—	—	150	—	—	150	—	—	150	$\mu A$
$I_{IL}$	Input LOW Current <sup>(2)</sup> (D, CLK, MR)	0.5	—	—	0.5	—	—	0.5	—	—	0.5	—	—	$\mu A$
$I_{CC}$	Supply Current <sup>(3)</sup>	8	14	25	8	14	25	8	14	25	8	14	25	mA
$I_{OH}$	Output HIGH Current <sup>(4)</sup> (MR LOW) <sup>(5)</sup>	60	64	68	60	64	68	60	64	68	60	64	68	mA 5
$I_{OL}$	Output LOW Current (MR HIGH)	—	—	500	—	—	500	—	—	500	—	—	500	$\mu A$
$I_{OR}$	Output Current Ringing <sup>(6)</sup>	—	—	10	—	—	10	—	—	10	—	—	10	%
$I_{O\text{mod}}$	Laser Diode Modulation Current Range	5	—	60	5	—	60	5	—	60	5	—	60	mA

**NOTES:**

- $R_{SET} = 10\Omega \pm 1\%$
- $V_I = V_{IL}$  (Min.)
- $V_{I\text{mod}} = V_{CC}$
- $V_{I\text{mod}} = -3.5V$
- $V_{L\text{mod}} = -0.8V$
- $I_{OH} = 5$  to  $60mA$

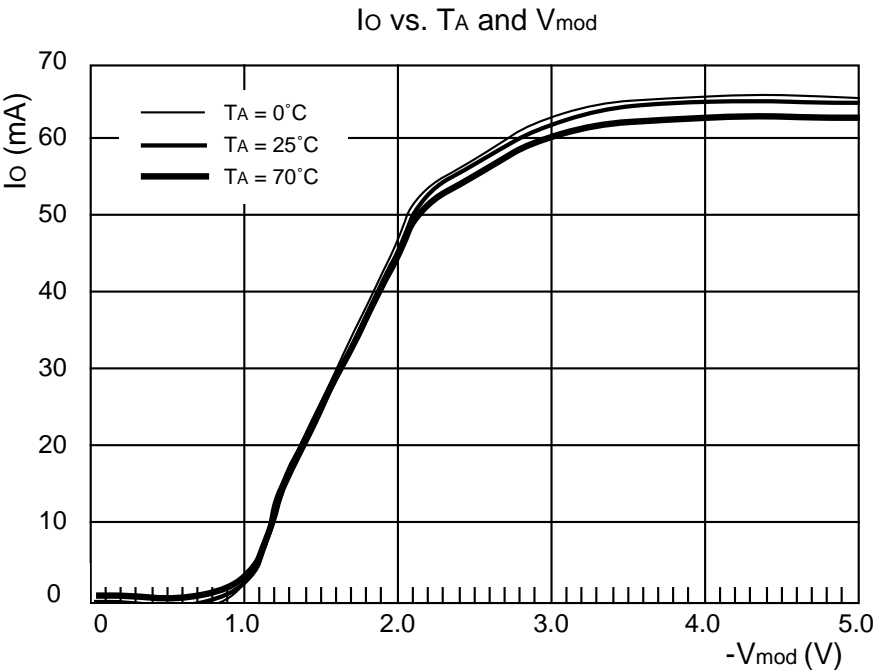
**AC ELECTRICAL CHARACTERISTICS<sup>(1)</sup>**

Symbol	Parameter	$T_A = -40^\circ C$			$T_A = 0^\circ C$			$T_A = +25^\circ C$			$T_A = +85^\circ C$			Unit
		Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.	
$t_{pd}$ CLK	Propagation Delay CLK - OUT	—	—	1000	—	—	1000	—	—	1000	—	—	1000	ps
$t_{pd}$ MR	Propagation Delay MR - OUT	—	—	1000	—	—	1000	—	—	1000	—	—	1000	ps
$t_r$ $t_f$	Rise/Fall Time (20% to 80%)	—	—	400	—	—	400	—	—	400	—	—	400	ps
$t_S$	Set-up Time	100	—	—	100	—	—	100	—	—	100	—	—	ps
$t_H$	Hold Time	200	—	—	200	—	—	200	—	—	200	—	—	ps
$t_{PW}$	Minimum Pulse Width (CLK, MR)	400	—	—	400	—	—	400	—	—	400	—	—	ps

**NOTE:**

- $R_{SET} = 10\Omega \pm 1\%$ ,  $R_{EXT} = R_{SER} = 50\Omega \pm 1\%$

PERFORMANCE CURVES



PRODUCT ORDERING CODE

Ordering Code	Package Type	Operating Range	Marking Code
SY100EL1001ZC	Z16-2	Commercial	XEL1001
SY100EL1001ZCTR*	Z16-2	Commercial	XEL1001

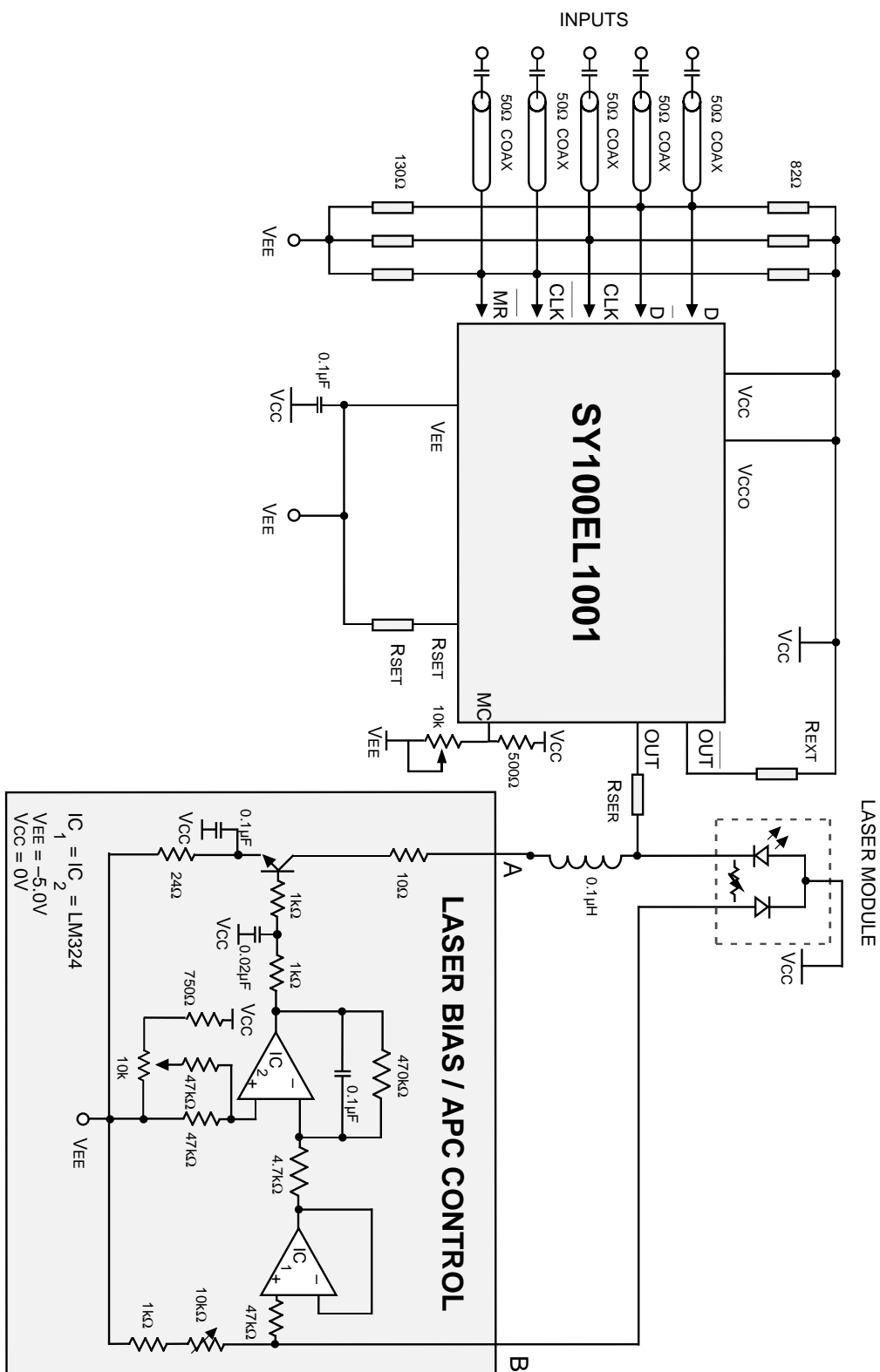
Ordering Code	Package Type	Operating Range	Marking Code
SY100EL1001ZI <sup>(1)</sup>	Z16-2	Industrial	XEL1001
SY100EL1001ZITR <sup>*(1)</sup>	Z16-2	Industrial	XEL1001

\*Tape and Reel

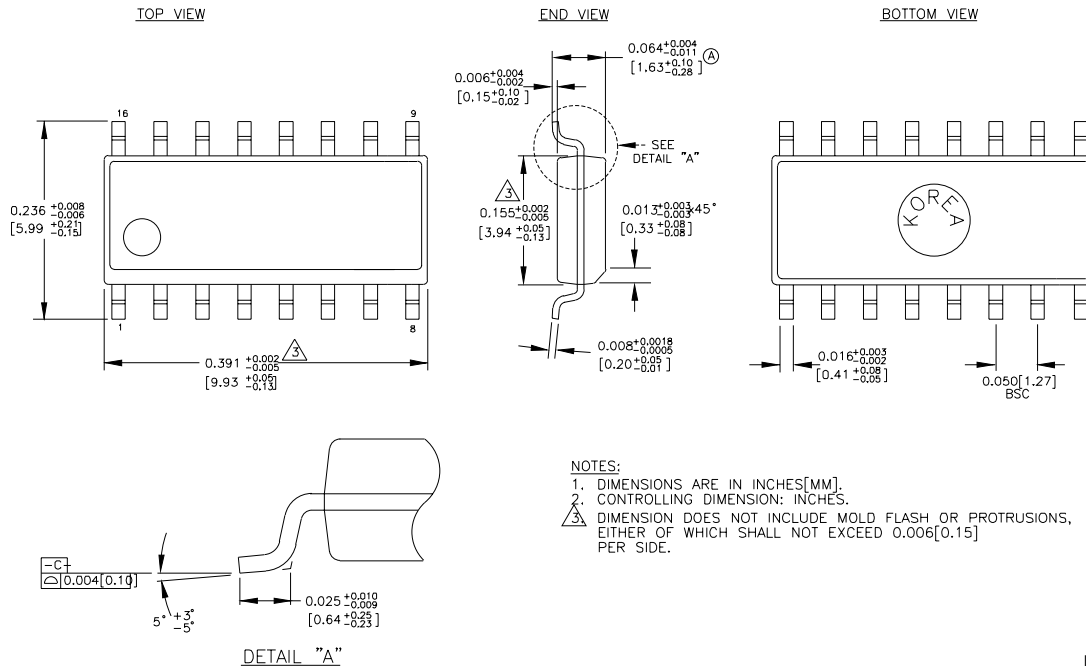
**Note 1.** Recommended for new designs.

**NOTES:**

1. Split 100K ECL terminations are 82 $\Omega$  and 130 $\Omega$  to Vcc and VEE respectively.
2. Recommended power supply bypass capacitors are 0.1 $\mu$ F with optional 10 $\mu$ F Tantalum in parallel.
3. High frequency design techniques are required for board layout. A double sided or multilayer board is recommended in conjunction with a low impedance ground plane and properly terminated transmission lines for all signal paths.
4. Vbb voltage pin may be used as reference for single ended input applications.



# 16 LEAD SOIC .150" WIDE (Z16-2)



Rev. 02

**MICREL, INC. 1849 FORTUNE DRIVE SAN JOSE, CA 95131 USA**

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